

Data sheet acquired from Harris Semiconductor SCHS050C - Revised October 2003

CMOS 4-Bit Magnitude Comparator

High Voltage Types (20-Volt Rating)

■ CD4063B is a 4-bit magnitude comparator designed for use in computer and logic applications that require the comparison of two 4-bit words. This logic circuit determines whether one 4-bit word (Binary or BCD) is "less than", "equal to", or "greater than" a second 4-bit word.

The CD4063B has eight comparing inputs (A3, B3, through A0, B0), three outputs (A < B, A = B, A > B) and three cascading inputs (A < B, A = B, A > B) that permit systems designers to expand the comparator function to 8, 12, 16 . . . 4N bits. When a single CD4063B is used, the cascading inputs are connected as follows: (A < B) = Iow, (A = B)= high, (A > B) = low.

For words longer than 4 bits, CD4063B devices may be cascaded by connecting the outputs of the less-significant comparator to the corresponding cascading inputs of the more-significant comparator. Cascading inputs (A < B, A = B, and A > B) on the least significant comparator are connected to a low, a high, and a low level, respectively.

The CD4063B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). This device is pin-compatible with the standard 7485 TTL type.

Features:

- Expansion to 8, 12, 16....4N bits by cascading units
- Medium-speed operation:

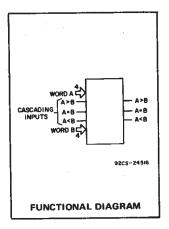
compares two 4-bit words in 250 ns (typ.) at 10 V

- 100% tested for quiescent current at 20 V
- Standardized symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 µA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- # Noise margin (full package temperature range)

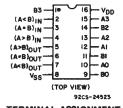
■ Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

■ Servo motor controls ■ Process controllers



CD4063B Types



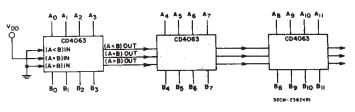
TERMINAL ASSIGNMENT

MAXIMUM RATINGS, Absolute-Maximum Values:

	DC SUPPLY-VOLTAGE RANGE, (VD
0.5V to +20V	Voltages referenced to VSS Termina
0.5V to V _{DD} +0.5V	INPUT VOLTAGE RANGE, ALL INPUT
±10mA	DC INPUT CURRENT, ANY ONE INPU
	POWER DISSIPATION PER PACKAC
500mW	For $T_A = -55^{\circ}C$ to $+100^{\circ}C$
Derate Linearity at 12mW/ ^o C to 200mW	For TA = +100°C to +125°C
	DEVICE DISSIPATION PER OUTPUT
ATURE RANGE (All Package Types)	FOR TA = FULL PACKAGE-TEMPI
T _A)55°C to +125°C	OPERATING-TEMPERATURE RANG
g)65°C to +150°C	STORAGE TEMPERATURE RANGE (
ERING);	LEAD TEMPERATURE (DURING SO
.79mm) from case for 10s max ,	At distance 1/16 ± 1/32 inch (1.59

RECOMMENDED OPERATING CONDITIONS For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

operation is arrest and			
	LIĀ	AITS	
CHARACTERISTIC	Min.	Max.	UNITS
Supply-Voltage Range (For T _A =Full Package- Temperature Range)	3	18	٧



TOTAL TO (COMPARE) + 3 x to (CASCADE), AT VDD = 10V (3 STAGES) = 250 + (2 x 200) = 650 ns (TYP.)

Fig. 1 — Typical speed characteristics of a 12-bit comparator.

CD4063B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER-	CONE	AOITIC	IS	LIMI	LIMITS AT INDICATED TEMPERATURES (°C)						
ISTIC	V _O	VIN	VDD						+25		UNITS
	(V)	(V)	(V)	55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent Device	· · -	0,5	5	5	5	150	150		0.04	5	
Current,		0,10	10	10	10	300	300	-	0.04	10	1.
IDD Max.		0,15	15	20	20	600	600	-	0.04	20	μА
	. –	0,20	20	100	100	3000	3000	-	0.08	100	1
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-	
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6		1
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	_	
Output High (Source) Current, IOH Min.	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	_	
	9,5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_	
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Voltage:	_	0,5	5		0	.05		_	0	0.05	
Low-Level, VOL Max.	. –	0,10	10		0	.05			0	0.05	
AOL Max.	_	0,15	15		0	.05			0	0.05	V
Output Voltage:	-	0,5	5	_	4.95				5	_	
High-Level,		0,10	10		9	.95		9.95	10		1
VOH Min.	_	0,15	15		14	.95		14.95	15	-	
Input Low	0.5, 4.5	_	5		1	.5		_	_	1.5	
Voltage,	1, 9	_	10			3		_	_	. ∍3	
VIL Max.	1.5,13.5	_	15			4		_	_	4	
Input High	0.5, 4.5	_	5		3	.5		3.5		_	٧
Voltage,	1, 9		10			7		7	_	_	
VIH Min.	1.5,13.5	-	15		11				_	_	
Input Current IJN Max.	-	0,18	18	±0.1	±0.1	±1	±1	_	±10-5	±0.1	μА

TRUTH TABLE

				_						
	COMPA	RING		(CASCADI	VG	OUTPUTS			
A3, B3	A2, B2	A1, B1	A0, B0	A < B	A = B	A > B	A < B	A = B	A > 8	
A3 > B3	X	Х	Х	Х	×	Х	0	0	1	
A3 = B3	A2 > B2	X	Χ .	×	×	х	0	0	1	
A3 = B3	A2 = B2	A1>B1	X ·	×	×	X	0	0	1	
A3 = B3	A2 = B2	A1 = B1	A0 > B0	×	X.	×	0	0	1	
A3 = B3	A2 = B2	A1 = B1	A0 = B0	0	0	1	0	0	1	
A3 = B3	A2 = B2	A1 = B1	A0 = B0	0	1	0	0	1	0	
A3 = B3	A2 = B2	A1 = B1	A0 = 80	1.1	0	0	1	0	0	
A3 = B3	A2 = B2	A1 = B1	A0 < B0	×	Х	X	1	0	0	
A3 = B3	A2 = B2	A1 < B1	×	х	х	X .	1	0	0	
A3 = B3	A2 < B2	x :	X	×	×	X ·	1	0	0	
A3 < B3	x	х	х	·x	i x	x -	- 1	0	0	

X = Don't Care

Logic 1 ≡ High Level

Logic 0 ≡ Low Level

CD4063B Types

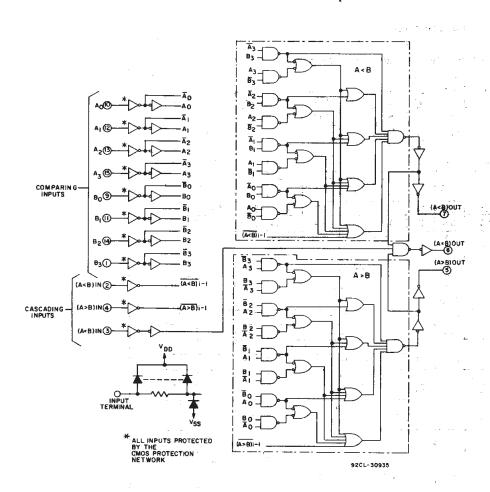


Fig. 2 - Logic diagram for CD4063B.

DYNAMIC ELECTRICAL CHARACTERISTICS

At $T_A = 25^{\circ}C$; Input t_r , $t_f = 20$ ns, $C_L = 50$ pF, $R_L = 200$ k Ω

CHADACTERICTIC	TEST CONDI	TIONS	Lii		
CHARACTERISTIC	**************************************	V _{DD} Volts	Тур.	Max.	UNITS
Propagation Delay Time:	!	5	625	1250	1
Comparing Inputs to		10	250	500	
Outputs, tpHL, tpLH		15	175	350	ns
		5	500	1000	1 '''
Cascading Inputs to	. ,	10	200	400	
Outputs, tpHL, tpLH		15	140	280	10 T
		5	100	200	
Transition Time,		10	50	100	ns
tthL/ttlh		15	40	80	
Input Capacitance, CIN	Any Input		5	7,5	pF

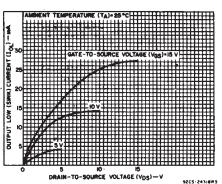


Fig. 3 — Typical output low (sink) current characteristics.

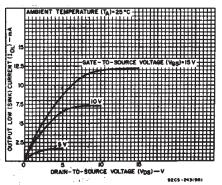


Fig. 4 — Minimum output low (sink) current characteristics.

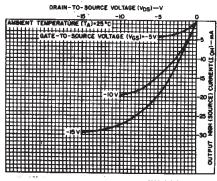


Fig. 5 — Typical output high (source) current characteristics.

Fig. 6 — Minimum output high (source) current characteristics.

CD4063B Types

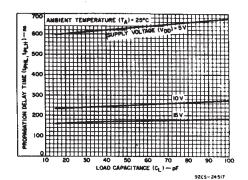


Fig. 7 — Typical propagation delay time vs. load capacitance ("comparing inputs" to outputs).

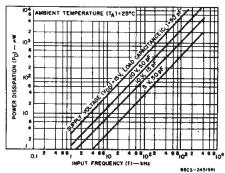


Fig. 10 — Typical power dissipation vs. frequency (see Fig. 12 — dynamic power dissipation test circuit).

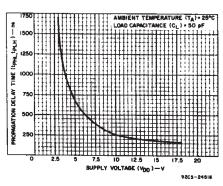


Fig. 8 — Typical propagation delay time vs. supply voltage ("comparing inputs" to outputs).

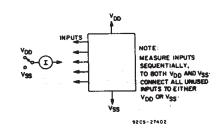


Fig. 11 - Input current test circuit.

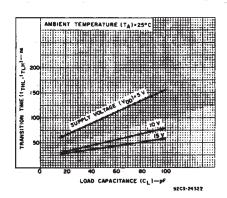


Fig. 9 - Typical transition time vs. load capacitance.

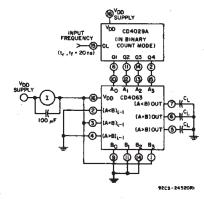


Fig. 12 - Dynamic power dissipation test circuit.

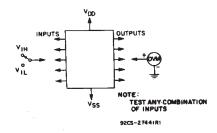


Fig. 13 - Input-voltage test circuit.

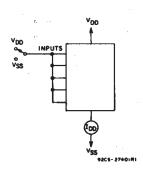
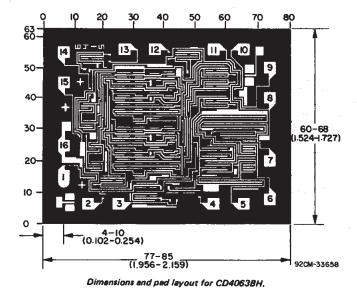


Fig. 14 - Quiescent-device-current test circuit.



Dimensions in parentheses are in millimeters and are derived from the besic inch dimensions as indicated. Grid graduations are in mils $(10^{-3} \, {\rm inch})$.





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty		Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
CD4063BE	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4063BE	Samples
CD4063BEE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4063BE	Samples
CD4063BF	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	CD4063BF	Samples
CD4063BF3A	ACTIVE	CDIP	J	16	1	Non-RoHS & Non-Green	SNPB	N / A for Pkg Type	-55 to 125	CD4063BF3A	Samples
CD4063BM	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063BM	Samples
CD4063BM96	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063BM	Samples
CD4063BM96E4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063BM	Samples
CD4063BMT	ACTIVE	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063BM	Samples
CD4063BMTG4	ACTIVE	SOIC	D	16	250	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063BM	Samples
CD4063BNSR	ACTIVE	so	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4063B	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



PACKAGE OPTION ADDENDUM

10-Dec-2020

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF CD4063B, CD4063B-MIL:

Catalog: CD4063B

Military: CD4063B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4063BM96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD4063BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4063BM96	SOIC	D	16	2500	333.2	345.9	28.6
CD4063BNSR	SO	NS	16	2000	853.0	449.0	35.0

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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